Special Issue

Laser Percussion Drilling Technology

Message from the Guest Editors

Laser percussion drilling, a non-contact machining process, has attracted strong interest from industry due to its wide range of industrial applications, smaller beam spot size, high operating speeds, great flexibility and accuracy, and capability to process various materials, including metals, glass, and ceramics. This Special Issue aims to highlight the state of the art in the development of laser percussion drilling and electric/magnetic/gas field-assisted laser drilling, process monitoring and characterizations of laser-material interactions. It also focuses on hybrid processes in manufacturing with laser-assisted micromachining. Chao-Ching Ho
Yuan-Jen Chang

Guest Editors

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Editor-in-Chief

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